

Silicon Carbide Power MOSFET N-Channel Enhancement Mode

Features

- · Optimized package with separate driver source pin
- Lower profile TO-247-4 package body
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q,,)
- · Halogen free, RoHS compliant

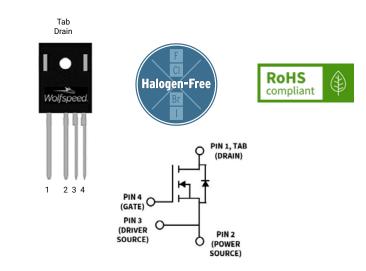
Benefits

- · Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- · Increase system switching frequency

Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters
- Solar/ESS
- UPS
- · Enterprise PSU

Package



Part Number	Package	Marking		
C3M0075120K1	T0-247-4L LP	C3M0075120K1		

Key Parameters

Parameter	Symbol	Min.	Тур.	Max	Unit	Conditions	Note
Drain - Source Voltage	V _{DS}			1200		T _c = 25°C	
Maximum Gate - Source Voltage	V _{GS(max)}	-8		+19	v	Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
				32		$V_{GS} = 15 \text{ V}, T_{C} = 25 \text{ °C}, T_{J} \le 175 \text{ °C}$	Fig. 19
DC Continuous Drain Current	l _D			23	Α	$V_{GS} = 15 \text{ V}, T_{C} = 100 \text{ °C}, T_{J} \le 175 \text{ °C}$	Note 2
Pulsed Drain Current	I _{DM}			80		t_{Pmax} limited by T_{jmax} $V_{GS} = 15V, T_{C} = 25 °C$	Fig. 22
Power Dissipation	P _D			145	W	$T_{c} = 25 ^{\circ} \text{C}, T_{J} = 175 ^{\circ} ^{\circ} ^{\circ}$	Fig. 20
Operating Junction and Storage Temperature	T _J , T _{stg}			-40 to +175	°C		
Solder Temperature	T _L			260		According to JEDEC J-STD-020	
Mounting Torque	M _D			1 8.8	Nm lbf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

Electrical Characteristics ($T_c = 25$ °C unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1200			V	V _{GS} = 0 V, I _D = 100 μA	
V	Gate Threshold Voltage	1.8	2.6	3.8	V	$V_{DS} = V_{GS}$, $I_D = 5 \text{ mA}$	Fig. 11
$V_{GS(th)}$			2.1		٧	$V_{DS} = V_{GS}$, $I_{D} = 5mA$, $T_{J} = 175^{\circ}C$	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μΑ	V _{DS} = 1200 V, V _{GS} = 0 V	
I_{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V	
$R_{DS(on)}$	Drain-Source On-State Resistance		75	97.5	mΩ	V _{GS} = 15 V, I _D = 17.9 A	Fig. 4,
US(on)	Drain Godice on State Resistance		135			V _{GS} = 15 V, I _D = 17.9 A, T _J = 175°C	5, 6
\mathbf{g}_{fs}	Transconductance		11		s	V _{DS} = 20 V, I _{DS} = 17.9 A	Fig. 7
91s	Transconductance		10.5		Ŭ	V _{DS} = 20 V, I _{DS} = 17.9 A, T _J = 175°C	
C_{iss}	Input Capacitance		1480				
C_{oss}	Output Capacitance		58		pF	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{V to } 1000 \text{ V}$	Fig. 17, 18
C_{rss}	Reverse Transfer Capacitance		2.7			F = 1 MHz	
E _{oss}	C _{oss} Stored Energy		32		μJ	Vac = 25 mV	Fig. 16
C _{o(er)}	Effective Output Capacitance (Energy Related)		67		pF	V _{GS} = 0 V, V _{DS} = 0 800V	Note: 3
$C_{o(tr)}$	Effective Output Capacitance (Time Related)		96		pF		
E _{on}	Turn-On Switching Energy (External Diode)		280			V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_{D} = 20 A,	Fig. 26, 28
E _{OFF}	Turn Off Switching Energy (External Diode)		56		μJ	$R_{G(ext)}$ = 2.5 Ω, L= 98 μH, T_J = 175°C FWD = External SiC DIODE	
Eon	Turn-On Switching Energy (Body Diode FWD)		280			V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_{D} = 20 A,	Fig. 26, 28
E _{OFF}	Turn-Off Switching Energy (Body Diode FWD)		63		μJ	$R_{G(ext)}$ = 2.5 Ω, L= 156 μH, T_J = 175°C FWD = Internal Body Diode	
$t_{\text{d(on)}} \\$	Turn-On Delay Time		8				Fig. 27, 28
t _r	Rise Time		22			V_{DD} = 800 V, V_{GS} = -4 V/15 V I_D = 20 A, $R_{G(ext)}$ = 2.5 Ω , Timing relative to V_{DS}	
$t_{\text{d(off)}}$	Turn-Off Delay Time		29		ns		
t f	Fall Time		11]	Inductive load	
R _{G(int)}	Internal Gate Resistance		9.0		Ω	f = 1 MHz, V _{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		17		V 900 V V 4 V (4 F V		
Q_{gd}	Gate to Drain Charge		18		nC	V_{DS} = 800 V, V_{GS} = -4 V/15 V I_{D} = 17.9 A	Fig. 12
Qg	Total Gate Charge		55	7	Per IEC60747-8-4 pg 21		

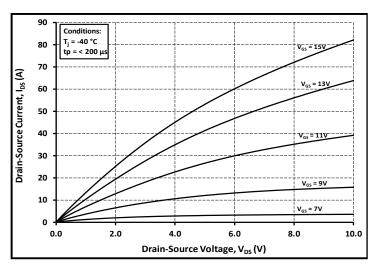
Note (3): Co(er), a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 800V Co(tr), a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 800V

Reverse Diode Characteristics (T_c = 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note	
V	Diode Forward Voltage	4.8		٧	$V_{GS} = -4 \text{ V, I}_{SD} = 9 \text{ A, T}_{J} = 25 \text{ °C}$	Fig. 8,	
V _{SD}		4.2		٧	V _{GS} = -4 V, I _{SD} = 9 A, T _J = 175 °C	9, 10	
Is	Continuous Diode Forward Current		27	Α	V _{GS} = -4 V, T _C = 25°C		
I _{SM}	Diode pulse Current		80	Α	V_{GS} = -4 V, pulse width t_p limited by T_{jmax}		
t _{rr}	Reverse Recover time	20		ns			
Q _{rr}	Reverse Recovery Charge	376		nC	V _{GS} = -4 V, I _{SD} = 20 A, V _R = 800 V dif/dt = 5280 A/μs, Τ _J = 175 °C		
I _{rrm}	Peak Reverse Recovery Current	25		Α			
t _{rr}	Reverse Recover time	28		ns			
Q _{rr}	Q _{rr} Reverse Recovery Charge			nC	V _{es} = -4 V, I _{so} = 20 A, V _R = 800 V dif/dt = 1305 A/μs, Τ _ι = 175 °C		
I _{rrm}	Peak Reverse Recovery Current	16		Α	α, α		

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
$R_{ heta JC}$	Thermal Resistance from Junction to Case	0.88	°C/W		Fig. 21



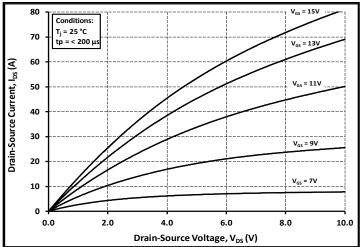
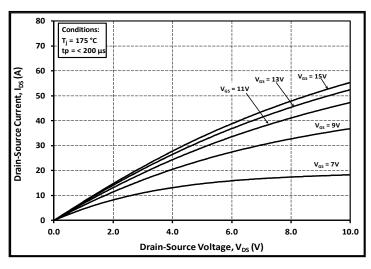


Figure 1. Output Characteristics T_J = -40 °C

Figure 2. Output Characteristics T_J = 25 °C



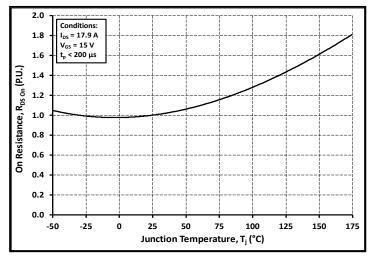
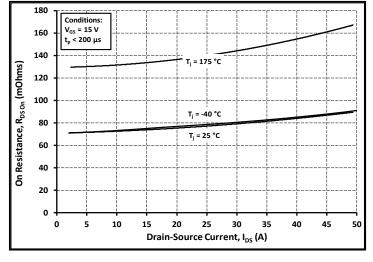


Figure 3. Output Characteristics T_J = 175 °C

Figure 4. Normalized On-Resistance vs. Temperature



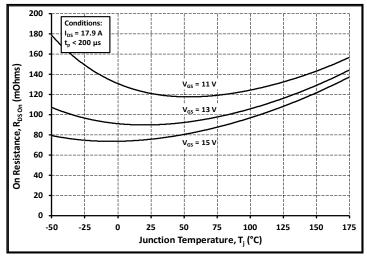
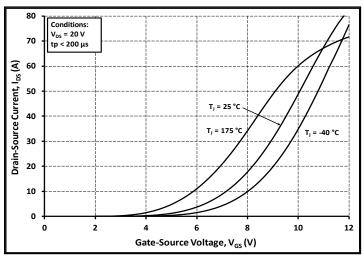
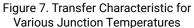


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage





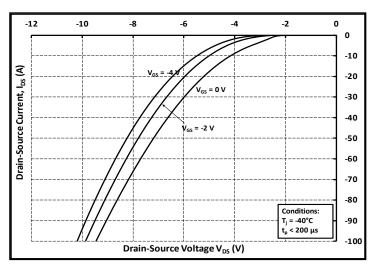


Figure 8. Body Diode Characteristic at -40 °C

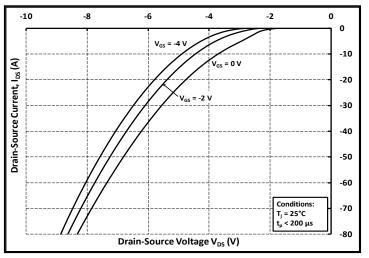


Figure 9. Body Diode Characteristic at 25 °C

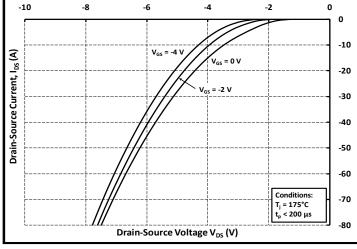


Figure 10. Body Diode Characteristic at 175 °C

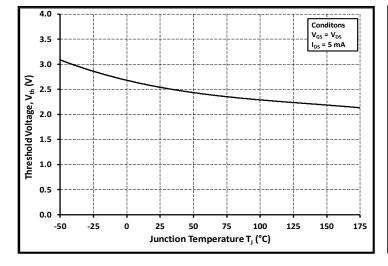


Figure 11. Threshold Voltage vs. Temperature

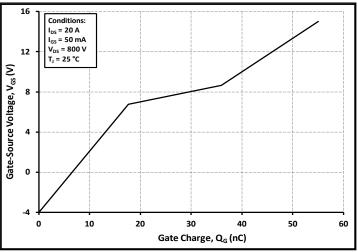
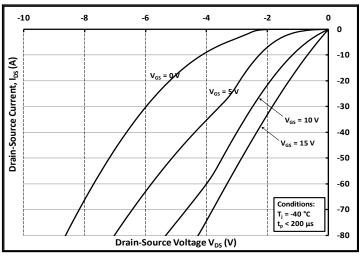


Figure 12. Gate Charge Characteristics

Typical Performance





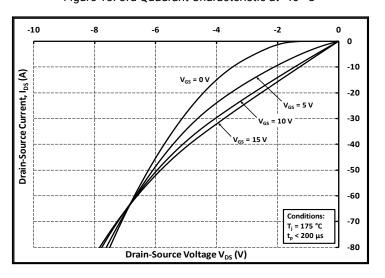


Figure 15. 3rd Quadrant Characteristic at 175 °C

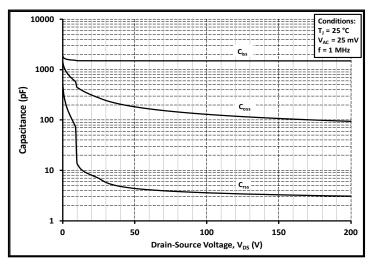
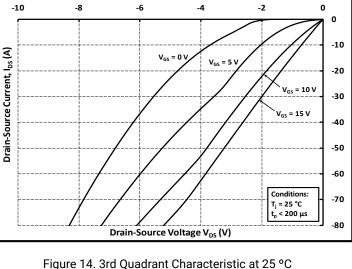


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)



50 40 40 sos (III) 20 0 200 400 600 800 1000 1200

Figure 16. Output Capacitor Stored Energy

Drain to Source Voltage, V_{DS} (V)

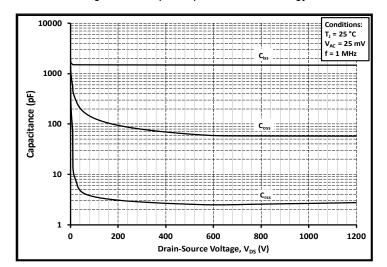
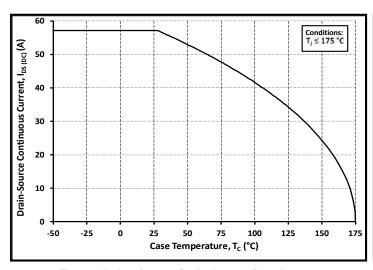


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)



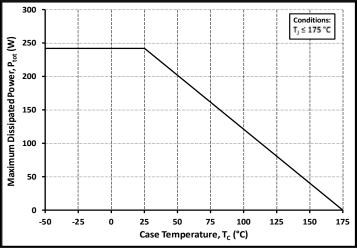
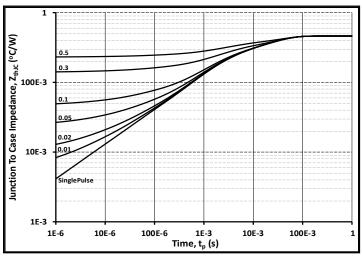


Figure 19. Continuous Drain Current Derating vs. Case Temperature

Figure 20. Maximum Power Dissipation Derating vs. Case Temperature



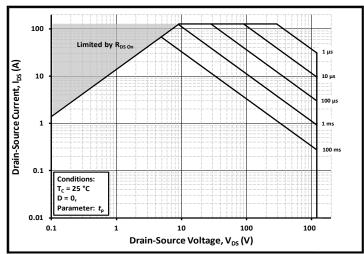
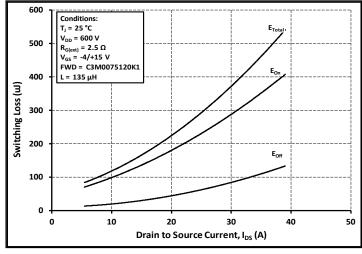


Figure 21. Transient Thermal Impedance (Junction - Case)

Figure 22. Safe Operating Area



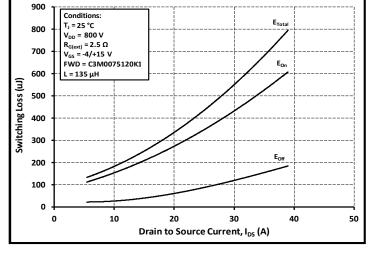


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

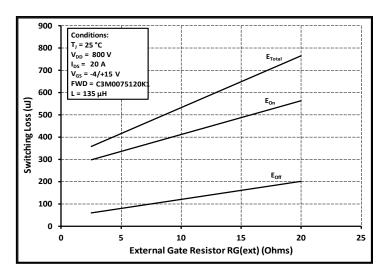


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

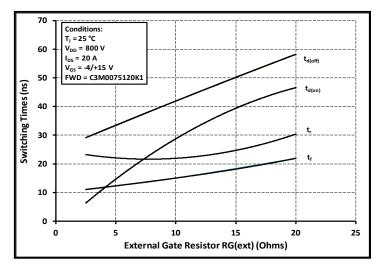


Figure 27. Switching Times vs. $R_{G(ext)}$

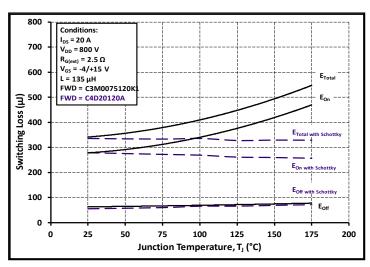


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

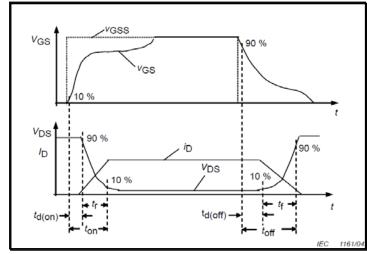


Figure 28. Switching Times Definition

9

Test Circuit Schematic

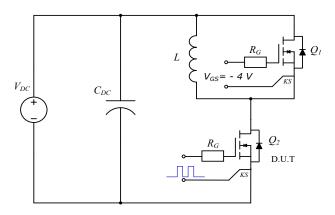
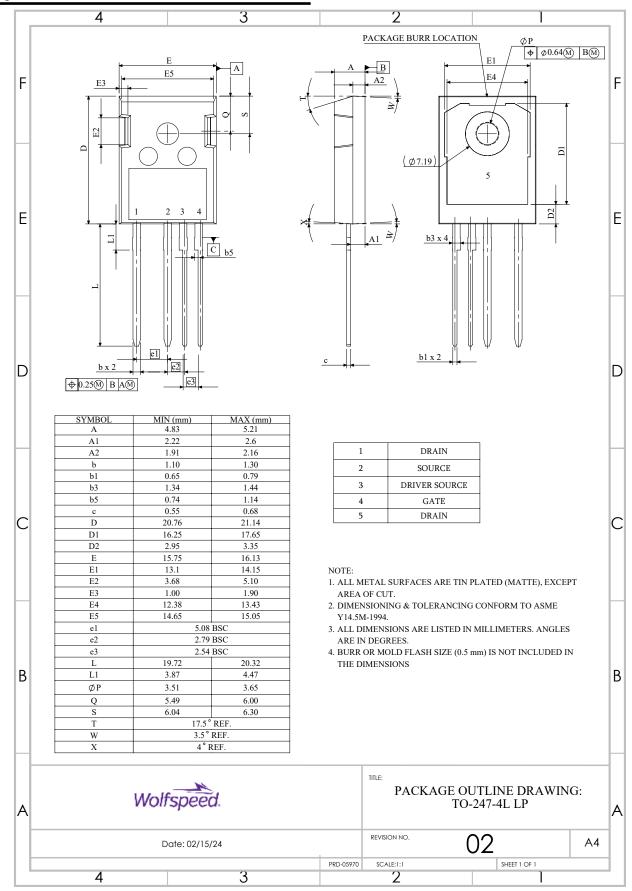


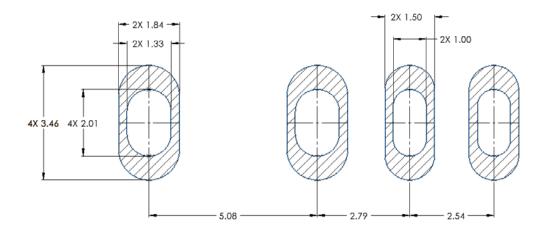
Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



Recommended Solder Pad Layout

All dimensions in mm



Revision history

Document Version	Date of release	Descriptiion of changes
1.0	April-2024	Initial datasheet

C3M0075120K1 1.

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